



PRODUCT BULLETIN
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25 Nov 2008

SUBJECT: ON Semiconductor Product Bulletin #16176

TITLE: SNSS20200WP Product Update: SEMI to JEIDA Wafer Flat Conversion

PROPOSED FIRST SHIP DATE: 5 Jan 2009

AFFECTED PRODUCT DIVISION: Standard Products Group

FOR ANY QUESTIONS CONCERNING THIS NOTIFICATION:

Contact your local ON Semiconductor sales office or Calvin Lim <calvin.lim@onsemi.com>

NOTIFICATION TYPE:

ON Semiconductor considers this change approved unless specific conditions of acceptance are provided in writing. To do so, contact your local ON Semiconductor sales office.

DESCRIPTION AND PURPOSE:

ON Semiconductor is notifying its customers, who purchase product in wafer form, of wafer flat conversion from SEMI to JEIDA flat. This is part of the initiative to standardize the usage of JEIDA-flat silicon material wafers across entire ON Semiconductor's internal wafer fabrication sites.

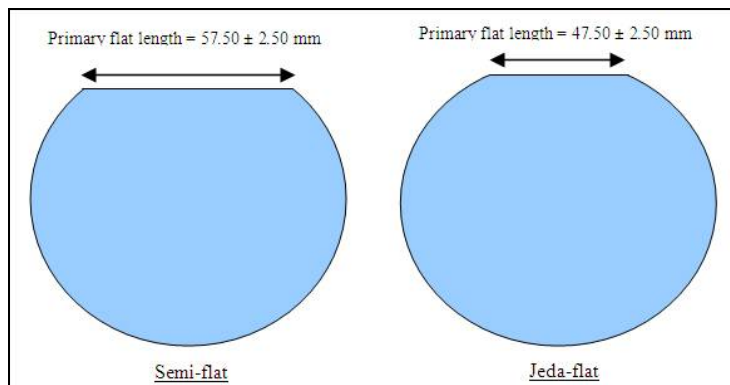
The difference between SEMI-flat and JEIDA-flat is through the primary flat length:

Semi primary flat length = 57.55 ± 2.5 mm

Jeida primary flat length = 47.50 ± 2.5 mm

Customers will continue to receive the same product they have been receiving all along, ie no change in physical die appearance, wafer fabrication process, electrical testing and packaging.

Products with date code 0901 (WW01) onwards may contain wafers with JEIDA-flat.





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AFFECTED DEVICE LIST

PART

SNSS20200WP